

**AMENDMENTS TO THE CLAIMS**

**This listing of claims will replace all prior versions and listings of claims in the application:**

**LISTING OF CLAIMS:**

1. (original): A gallium nitride compound semiconductor light-emitting device comprising:

a crystalline substrate (10);

a light-emitting layer (15) of a quantum well structure which is formed of a gallium nitride compound semiconductor barrier layer and a gallium nitride compound semiconductor well layer, which light-emitting layer is provided on a second side of the crystalline substrate;

a contact layer (17) formed of a Group III-V compound semiconductor for providing an Ohmic electrode for supplying device operation current to the light-emitting layer; and

an Ohmic electrode (18) which is provided on the contact layer and has an aperture through which a portion of the contact layer is exposed,

wherein the Ohmic electrode exhibits light permeability with respect to light emitted from the light-emitting layer, and the well layer contains a thick portion having a large thickness and a thin portion having a small thickness.

2. (original): A gallium nitride compound semiconductor light-emitting device according to claim 1, wherein the well layer contains a portion having a thickness of 1.5 nm to 0 nm.

3. (currently amended): A gallium nitride compound semiconductor light-emitting device according to claim 1 ~~or claim 2~~, wherein either the barrier layer or the well layer is doped with an impurity element.

4. (original): A gallium nitride compound semiconductor light-emitting device according to claim 3, wherein only the barrier layer is doped with an impurity element.

5. (original): A gallium nitride compound semiconductor light-emitting device according to claim 4, wherein the predetermined impurity element added only to the barrier layer is silicon.

6. (currently amended): A gallium nitride compound semiconductor light-emitting device according to claim 1 ~~any one of claims 1 to 5~~, wherein the contact layer (17) is doped with an n-type impurity element and has a carrier concentration of  $5 \times 10^{18} \text{ cm}^{-3}$  to  $2 \times 10^{19} \text{ cm}^{-3}$ .

7. (currently amended): A gallium nitride compound semiconductor light-emitting device according to claim 1 ~~any one of claims 1 to 6~~, wherein the contact layer (17) is doped with a p-type impurity element and has a carrier concentration of  $1 \times 10^{17} \text{ cm}^{-3}$  to  $1 \times 10^{19} \text{ cm}^{-3}$ .

8. (original): A gallium nitride compound semiconductor light-emitting device according to claim 7, wherein the contact layer (17) is doped with a p-type impurity element and has a carrier concentration of  $1 \times 10^{17} \text{ cm}^{-3}$  to  $5 \times 10^{18} \text{ cm}^{-3}$ .

9. (currently amended): A gallium nitride compound semiconductor light-emitting device according to claim 1 ~~any one of claims 1 to 8~~, wherein the contact layer (17) has a thickness of 1  $\mu\text{m}$  to 3  $\mu\text{m}$ .

10. (currently amended): A gallium nitride compound semiconductor light-emitting device according to claim 1 ~~any one of claims 1 to 9~~, wherein the Ohmic electrode (18) exhibits a transmittance at the wavelength of emitted light of 30% or higher.

11. (currently amended): A gallium nitride compound semiconductor light-emitting device according to claim 1 ~~any one of claims 1 to 10~~, wherein the Ohmic electrode (18) has a thickness of 1 nm to 100 nm.

12. (currently amended): A gallium nitride compound semiconductor light-emitting device according to claim 1 ~~any one of claims 1 to 11~~, further comprising a metallic reflecting mirror (21) for reflecting light emitted from the light-emitting layer (15) to the outside, which mirror is provided on a first side of the crystalline substrate (10), wherein the metallic reflecting mirror (21) contains a metallic material identical to that contained in the Ohmic electrode (18).

13. (original): A gallium nitride compound semiconductor light-emitting device according to claim 12, wherein the metallic reflecting mirror (18) has a multilayer structure including a

metallic film which contains a metallic material identical to that contained in the Ohmic electrode (18).

14. (currently amended): A gallium nitride compound semiconductor light-emitting device according to claim 1 ~~any one of claims 1 to 13~~, wherein the metallic reflecting mirror (21) contains a single-metal film or an alloy film formed from at least one member selected from the group consisting of silver, platinum, rhodium and aluminum.

15. (currently amended): A gallium nitride compound semiconductor light-emitting device according to claim 1 ~~any one of claims 1 to 14~~, wherein the metallic reflecting mirror (21) is in the form of multilayer film.

16. (currently amended): A light-emitting diode employing the gallium nitride compound semiconductor light-emitting device according to claim 1 ~~any one of claims 1 to 15~~.

17. (currently amended): A lamp employing the gallium nitride compound semiconductor light-emitting device according to claim 1 ~~any one of claims 1 to 15 or the light emitting diode according to claim 16~~.